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OCT 25 2004

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

Applicant Andrew Marshall

Docket Number: TI-31484

Serial No.: 10/007,332

Art Unit: 2815

Filed: 11/08/01

Examiner: Matthew E. Warren

For: Thermal Coupling of Matched SOI Device Bodies

CERTIFICATION OF FACSIMILE TRANSMISSION

I hereby certify that the following papers are being transmitted by facsimile to the U.S. Patent and Trademark Office on the date shown below:

Karen Vertz  
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10-25-04  
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FACSIMILE COVER SHEET

<input checked="" type="checkbox"/> FACSIMILE COVER SHEET	<input type="checkbox"/> AMENDMENT (# Pages)
<input type="checkbox"/> NEW APPLICATION	<input type="checkbox"/> EOT
<input type="checkbox"/> DECLARATION	<input checked="" type="checkbox"/> NOTICE OF APPEAL
<input type="checkbox"/> ASSIGNMENT	<input type="checkbox"/> APPEAL (# Pages)
<input type="checkbox"/> FORMAL DRAWINGS	<input type="checkbox"/> ISSUE FEE & PUBLICATION FEE (1 Page)
<input type="checkbox"/> INFORMAL DRAWINGS	<input type="checkbox"/> REPLY BRIEF (IN TRIPLICATE) (# Pages)
<input type="checkbox"/> CONTINUATION APPN	<input type="checkbox"/> ELECTION
<input type="checkbox"/> DIVISIONAL APPN	
NAME OF INVENTOR(S): Andrew Marshall	
TITLE OF INVENTION: Thermal Coupling of Matched SOI Device Bodies	
RECEIPT DATE & SERIAL NO.: Serial No.: 10/007,332 Filing Date: 11/08/01	
TITLE NO.: TI-31484	DEPOSIT ACCT. NO.: 20-0668
FAXED: 10-25-04 DUE: 10-26-04 ATTY/SECY: RAK/qv	

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Texas Instruments Incorporated  
PO Box 855474, M/S 3999  
Dallas, TX 75285-5474

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In re Application of

Andrew Marshall

TI-31484

Examiner: Matthew E. Warren

Art Unit 2815

Serial No.: 10/007,332

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For: Thermal Coupling of Matched SOI Device Bodies

NOTICE OF APPEAL FROM THE PRIMARY EXAMINER TO THE BOARD OF APPEALS

CERTIFICATION OF FACSIMILE TRANSMISSION	
I hereby certify that the above correspondence is being transmitted by facsimile to the U.S. Patent and Trademark Office at 703-872-9306 on the date shown below:	
<u>Karen Vertz</u> Karen Vertz	<u>10-25-04</u> Date

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

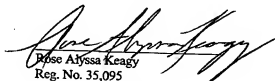
Applicant hereby appeals claims 6-13 and 15-19 to the Board of Appeals from the decision dated July 26, 2004 of the Primary Examiner finally rejecting claims 6-13 and 15-19.

The item(s) checked below are appropriate:

1. ☐ An extension of time to respond to the final rejection  
☐ was granted on \_\_\_\_  
☐ is requested for \_\_\_\_ month(s).
2. ☒ A timely response to the final rejection has been filed, as provided in 841 O.G. 1411.
3. ☒ Fee \$340.00:  
☐ Not required (Fee paid in prior appeal)  
☒ The Commissioner of Patents is hereby authorized to charge any fees which may be required, or credit any overpayment to Deposit Account No. 20-0668 of Texas Instruments Incorporated.

Signature [Rule 191(b)]:

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